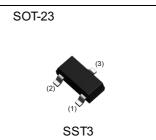


PNP Medium Power Transistor (Switching)

Parameter	Value
V _{CEO}	-40V
Ι _C	-600mA

Outline

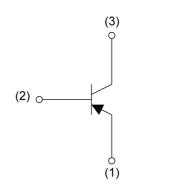


Features

1)BV_{CEO}=-40V(Min.); at I_C=-1mA

2)Complements the SST4401

Inner circuit



(1) Emitter(2) Base(3) Collector

Application

AUDIO FREQUENCY SMALL SIGNAL AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
SST4403	SOT-23 (SST3)	2924	T116	180	8	3000	R2T

● Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V _{CBO}	-40	V
Collector-emitter voltage	V _{CEO}	-40	V
Emitter-base voltage	V _{EBO}	-6	V
Collector current	Ι _C	-600	mA
	P _D ^{*1}	200	mW
Power dissipation	P _D *2	350	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

•Electrical characteristics (T_a = 25°C)

Derementer	Symbol	Canditiana	Values			Linit
Parameter		Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV_{CBO}	Ι _C = -100μΑ	-40	-	-	V
Collector-emitter breakdown BV		I _C = -1mA	-40	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	Ι _E = -100μΑ	-5	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = -35V	-	-	-100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = -5V	-	-	-100	nA
Collector-emitter saturation voltage	V _{CE(sat)} 1	I _C = -150mA, I _B = -15mA	-	-	-400	mV
	V _{CE(sat)} 2 ^{*3}	I _C = -500mA, I _B = -50mA	-	-	-750	mV
Base-emitter saturation voltage	V _{BE(sat)} 1	I _C = -150mA, I _B = -15mA	-750	-	-950	mV
	V _{BE(sat)} 2*3	I _C = -500mA, I _B = -50mA	-	-	-1.3	V
	h _{FE} 1	V _{CE} = -1V, I _C = -100µA	30	-	-	-
	h _{FE} 2	V _{CE} = -1V, I _C = -1mA	60	-	-	-
DC current gain	h _{FE} 3	V _{CE} = -1V, I _C = -10mA	100	-	-	-
	h _{FE} 4	V _{CE} = -1V, I _C = -150mA	100	-	300	-
	$h_{FE}5^{*3}$	V _{CE} = -2V, I _C = -500mA	20	-	-	-
Output capacitance	C _{ob}	V _{CB} = -10V, I _E = 0A f = 100kHz	-	-	8.5	pF
Input capacitance	C _{ib}	V _{BE} = -0.5V, I _C = 0A f = 100kHz	-	-	30	pF
Transition frequency	f _T	V _{CE} = -10V, I _E = 20mA f = 100MHz	200	-	-	MHz
Delay time	t _d	$V_{CC} \simeq -30V, I_{C} = -150mA$ $I_{B1} = -15mA, R_{L} = 200\Omega$	-	-	15	ns
Rise time	t _r	V _{BE(off)} = 2V See test circuit	-	-	20	ns
Storage time	t _{stg}	$V_{CC} \simeq -30V$ I _C = -150mA	-	-	225	ns
Fall time	t _f	I _{B1} = -15mA I _{B2} = 15mA, R _L = 200Ω See test circuit	-	-	30	ns

*1 Each terminal mounted on a reference land.

*2 Mounted on a ceramic board(7.0×5.0×0.6mm).



• Electrical characteristic curves ($T_a = 25^{\circ}C$)

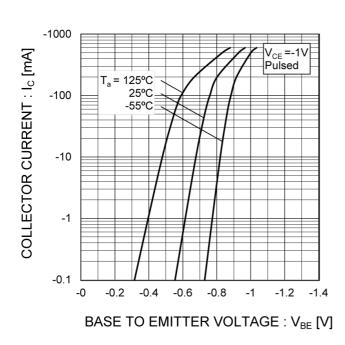


Fig.1 Ground Emitter Propagation Characteristics

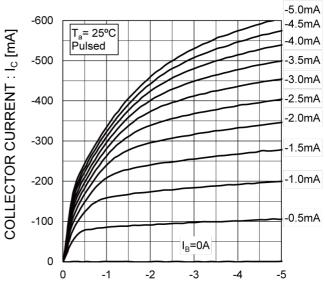


Fig.2 Typical Output Characteristics

COLLECTOR TO EMITTER VOLTAGE : V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

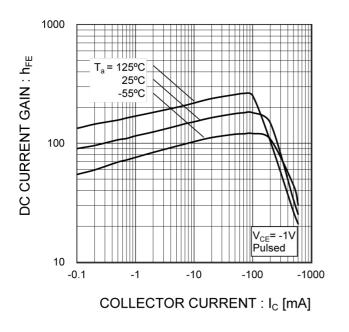
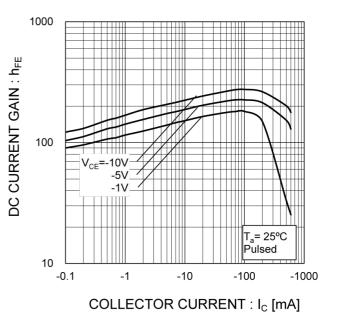


Fig.4 DC Current Gain vs. Collector Current (II)



●Electrical characteristic curves(T_a = 25°C)

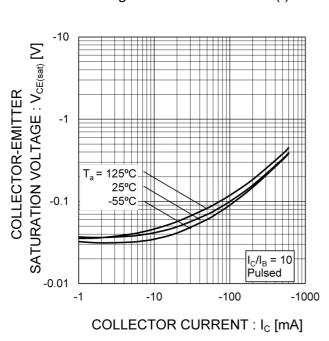
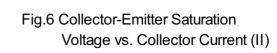


Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)



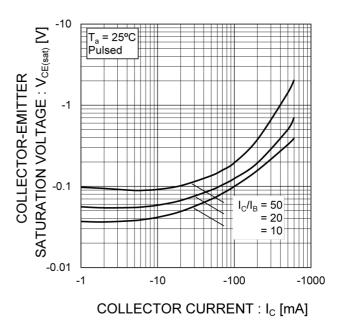


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

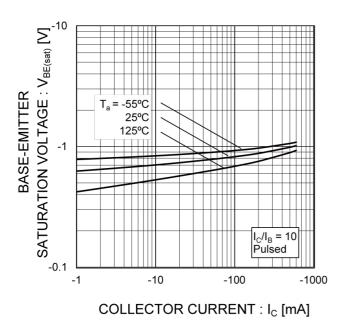
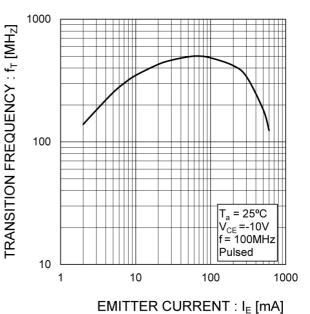


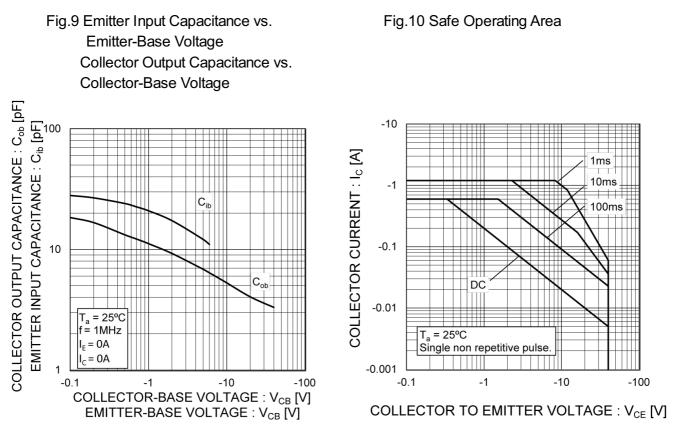
Fig.8 Gain Bandwidth Product vs. Emitter Current



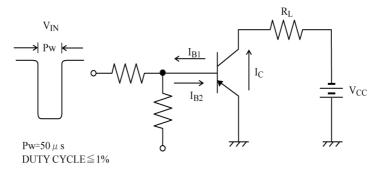


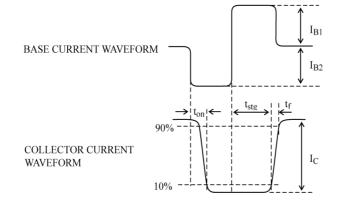
• Electrical characteristic curves ($T_a = 25^{\circ}C$)

SST4403



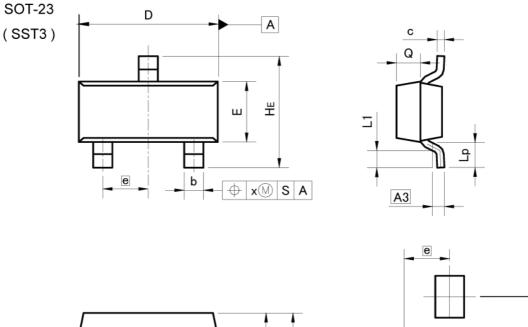
SWITCHING TIME TEST CIRCUIT

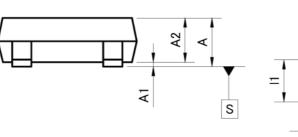


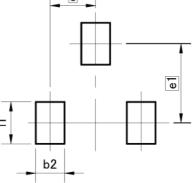




Dimensions







Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
A	0.90	1.20	0.035	0.047	
A1	0.00	0.10	0.000	0.004	
A2	0.85	1.15	0.033	0.045	
A3	0.:	25	0.0	10	
b	0.35	0.50	0.014	0.020	
с	0.09	0.25	0.004	0.010	
D	2.70	3.10	0.106	0.122	
E	1.20	1.50	0.047	0.059	
е	0.9	95	0.037		
HE	2.20	2.60	0.087	0.102	
L1	0.20	-	0.008	-	
Lp	0.30	. —	0.012		
Q	0.40	0.60	0.016	0.024	
x	-	0.10	-	0.004	
	ATT TAA	TEDO	TNIO	150	

DIM		ETERS	INCHES		
DIW	MIN MAX		MIN	MAX	
b2	-	0.60	-	0.024	
e1	1.1	70	0.0	67	
1		0.90	-	0.035	

Dimension in mm/inches



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JÁPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII	
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI	

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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